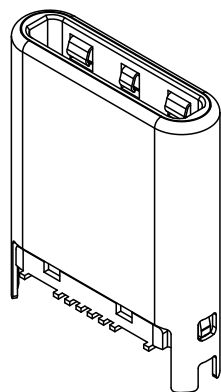
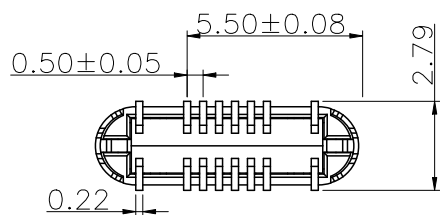
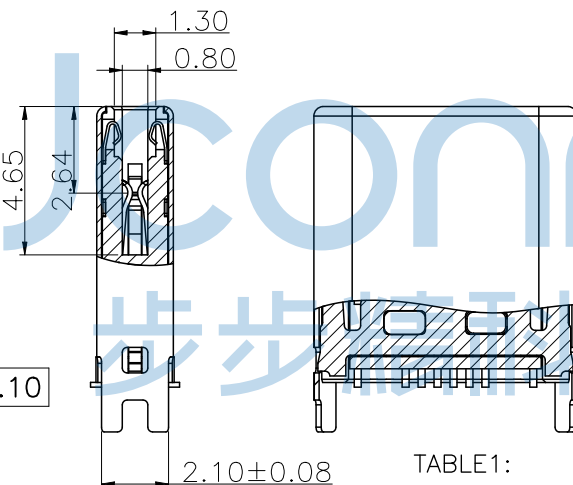
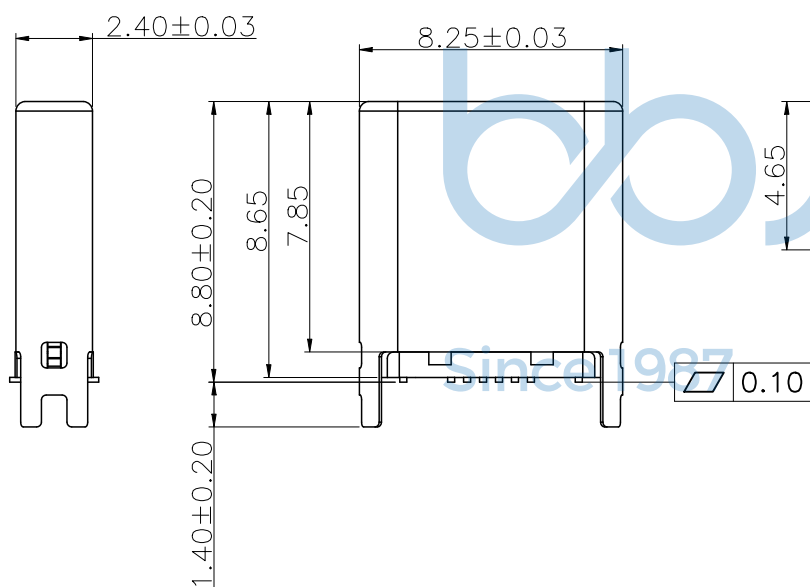


RECOMMENDED P.C.B. LAYOUT  
TOLERANCE UNSPECIFIED ±0.05mm



REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP

NOTES:

- Material: SEE TABLE1;
- Plating specification,
  - Contact: Contact area: Ni50u"Min/Au Solder area: Ni50u"Min/Sn100u"Min. Other area: Ni 50u"Min.
  - Shell: NI.
  - Latch: Solder area: Ni50u"Min/Sn100u"Min. Other area: Ni 50u"Min.
- Mechanical Performance ,
  - Insertion Force: 5~20N;
  - Extraction Force: 6~20N after 10000 cycles;
  - Durability: 10000 cycles.
- Electrical Performance,
  - Insulation Resistance: 100? Min.
  - Contact Resistance :50m? Max.
  - Dielectric Strength :100V AC.
- characteristic impedance: 100 Ohm±10%;
- Marked "▼" is the important control dimentions.
- The product accords with HF STD.



TABLE1:

5	EMC SPRING	Stainless Steel; SUS301, T=0.08mm;
4	CONTACT	Copper Alloy; AuNiSn;
3	LATCH	Stainless Steel; SUS301, T=0.40mm;
2	HOUSING	LCP Thermoplastic, UL94V-0;
1	SHELL	Stainless Steel; SUS316L, T=0.15mm;
NO.	NAME	DESCRIPTION

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**深圳市步步精科技有限公司**

NAME: TYPE-C 16P 公头 直立式 贴片 端子SMT 带EMC H=8.65

PJ. NO.: 126-124-160003-J8G

SIZE: A4 DRW NO.:

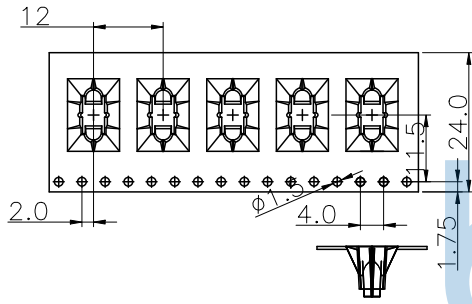
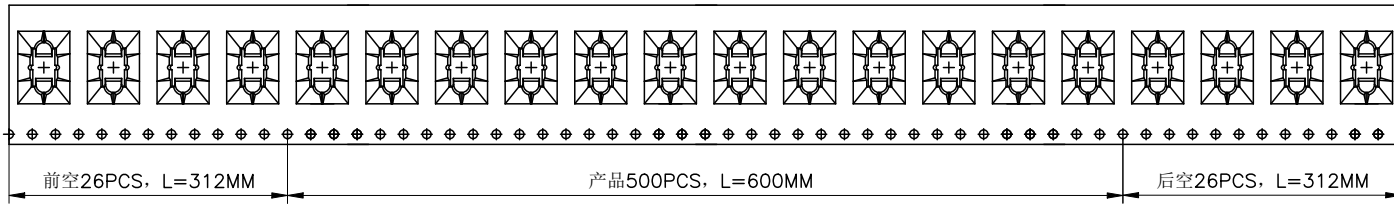
FINISH: SEE NOTES MAT'L.: SEE NOTES

SCALE: N/A REV.: A0 UNIT: mm PAGE: 1/2

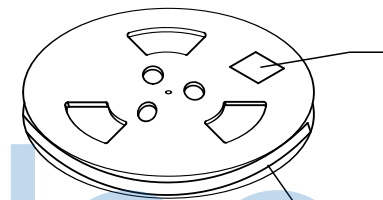
REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP

NOTE:

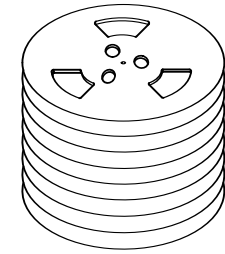
1. QUANTITY/REEL: 500 PCS  
數量/卷: 500 PCS  
QUANTITY/INNER CARTON: 500 X 10 = 5000 PCS  
數量/箱: 500 X 10 = 5000 PCS  
2. FREE 14 CAVE IN THE FRONT CARRIER AND FREE 14 CAVE IN THE END CARRIER.  
包裝帶內圈空26格, 外圈空26格.



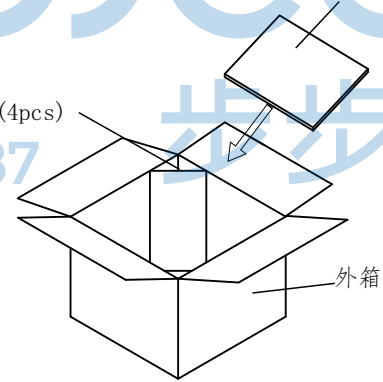
① 产品入载带示意图



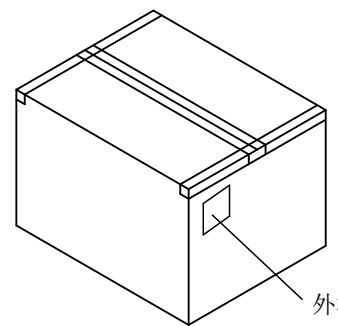
② 卷盘贴标签示意图



③ 10盘产品叠层示意图



④ 产品入外箱示意图



⑤ 外箱封箱示意图

1	卷盘	PS	ø330MM*W28.5MM	10
2	天地板	K3K		2
3	外标签			1
4	三角柱	K=K		4
5	外箱	A=A	L345mm*W345mm*315mm	1
6	防水袋	PS		1
7	干燥剂			1
ITEM	DESC.	MATERIAL	REMARKS	QTY



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**深圳市步步精科技有限公司**

NAME: TYPE-C 16P 公头 直立式 贴片 端子SMT 带EMC H=8.65

APPD. JM\_Zheng

CHKD. LYX

DR. TSP

PJ. NO.: 126-124-160003-J8G

SIZE: A4 | DRW NO.:

FINISH: SEE NOTES | MAT'L.: SEE NOTES

SCALE: N/A | REV.: A0 | UNIT: mm | PAGE: 2/2

PDWG. NO: 0500-1